OpenEdge ADLINK update May 14, 2019

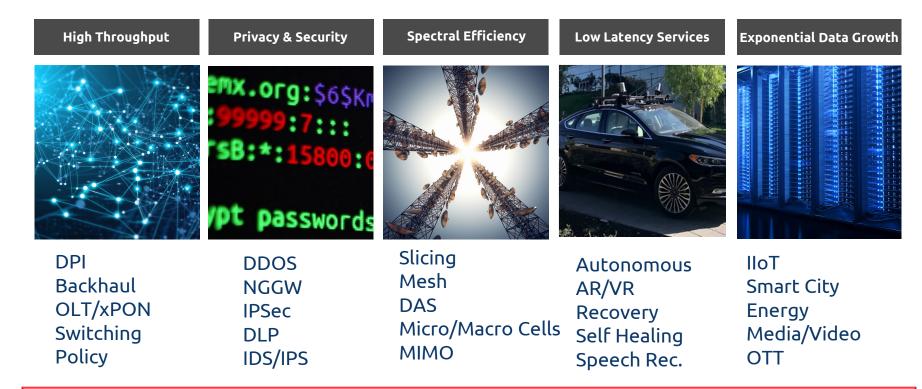
Jeff Sharpe Director, Product Strategy & Business Development





It's all about those killer apps

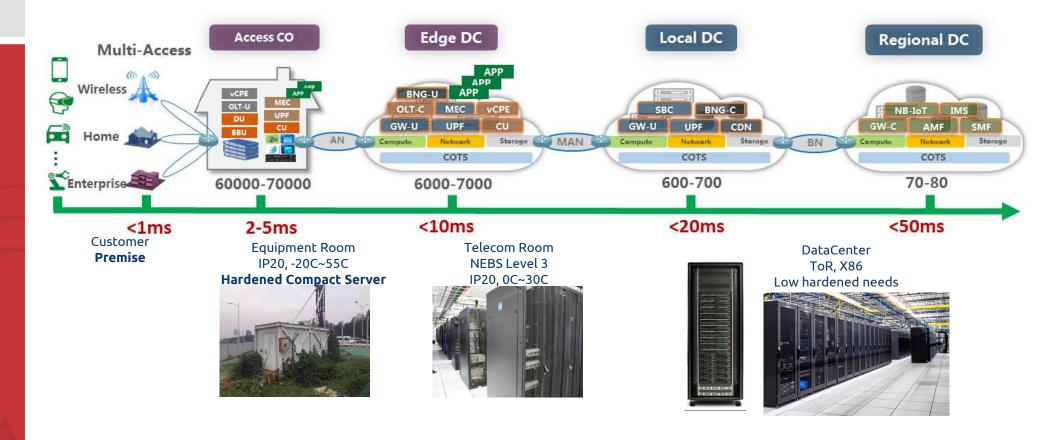




And most of all -> Increase Service Revenues while decreasing CAP/OPEX

Edge AI / DL at the Edge

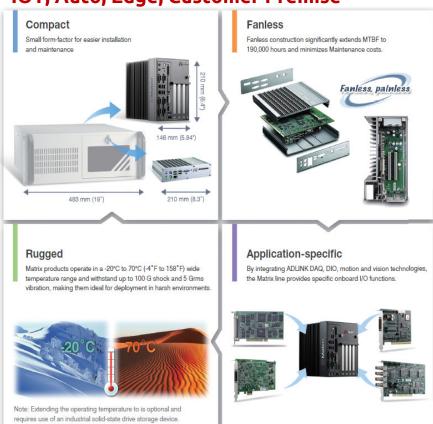


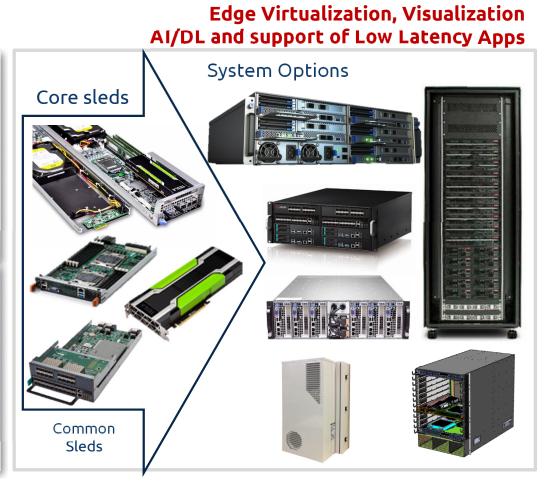


Edge-Focused Solutions



IOT Low Power Elements
IOT, Auto, Edge, Customer Premise





OCCERA Reusable Mix/Match Sleds &



Systems

OCCERA Compute Nodes

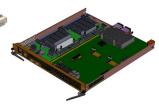
- Broadwell, Skylake, Purley (Skylake + FPGA)
- ½ and ¼ width sleds for needed core density
- Flexibility: mix and match E3 and E5
- Integrated NFVi Software and Platform S/W

MCN-2600

Broadwell



MCN-1500 (Greenlow GT4e)

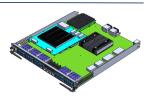


OCCERA Switching Nodes

- Intel Red Rock Canyon & Broadcom TH
- Extension trays for flexible I/O configs
- System Management and wide range of SW







I/O Nodes

- Optional Network Interface Modules
- Optical, copper, w and w/o bypass
- 1/4 width size to support large I/O options









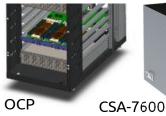


OCCERA Systems

- 19" 2U 4U and OCP-Telecom versions
- Data Center versions
- AC/DC power, NEBS ready, customizable
- Multiple options based on required solution









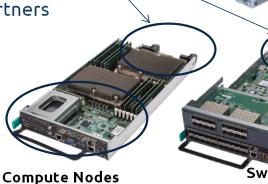
OCP OpenEdge Platform

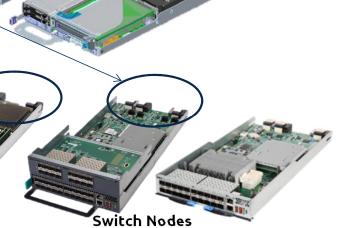


- OpenEdge 3U platform Sleds
 - Intel "RRC" FM10840 (960Mpps)
 - ⁻ Up to 360G for network interface
 - Compute Node MCN Modules
 - Common CPU (Dual Xeon with
 - ComE (Xeon D or E3) with onboard NVIDIA MXM modules
 - Xilinx FPGA for vOLT / SEBA / PoL w/ ComE for SDN
- Modify existing CPU/Switch sleds to interface the OpenEdge Sled profile (Rear PCIe and power connections)
- Modify front i/o card for OpenEdge Sled / add fans
- Need chassis and sled for lab work and testing
- Alignment with other OpenEdge Eco-system partners









2U Mountable containers for Edge







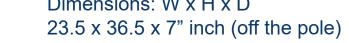


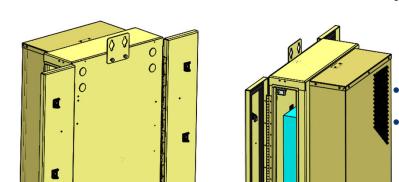
Small Cell Deployments – Pole Mount



Dimensions: W x H x D 23.5 x 36.5 x 7" inch (off the pole)

Server Rear





ADLINK MECS-7210

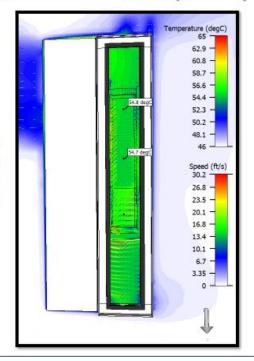
Heat Exchanger

- Low Profile Pole Mount Enclosure
- **Optional Integrated Power**
 - Power and battery or power only
 - **Optional Battery Compartment**
 - Heater for Cold Operation = 250W (32CFM)
 - Ambient Temperature & Solar Load: High Temp.
 - Operation = 46° C (115° F) w/ 0.5mph Wind
 - Cold Temp. Start = -40° C (-40° F) w/ 0.5mph Wind
 - Solar applied to three walls for High Temp. per Telcordia GR-487.
- Variable Speed Heat Exchanger: Maximum Capacity:
 - 1,880W (55W/°F)
 - Maximum Airflow: 530CFM
- Service Provider Approved

Thermals with CPU/GPU in pole mount



Thermal Results at 46°C (115°F) Ambient



Temperature Slice

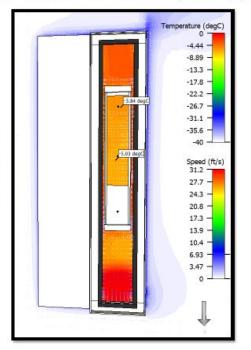
MECS-7210 Server

at the ADLINK

Intake

Thermal Results at -40°C (-40°F) Ambient

Temperature Slice at the ADLINK MECS-7210 Server Intake



Reduction in size / Meeting same environmental characteristics

- Reduce the overall depth of the enclosure, supporting a 2U edge server
- Market feedback Requirements
 - Reduction of the heat exchanger on the pole mounted enclosure
 - Replacement of CPU / GPU cooling with liquid cooling appliance
 - Introduction of a smaller radiator/heat exchanger into the chassis
- Driven by key edge use cases (Low Latency 5G small cell deployments)
 - Less visible
 - Self Contained and secure
 - Self healing and remote management
- Provide a design prototype for OpenEdge
 - Introduce a spec that enhances current design to include the option for liquid cooling
 - Gain agreement from specific silicon manufactures to participate with trials
 - Build out an eco-system of liquid cooling partners for introduction







